



100V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
400)/	$62m\Omega @ V_{GS} = 10V$	4A
100V	80mΩ @ V _{GS} = 6V	3.5A

Description

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

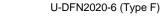
- Power Management Functions
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.

Features and Benefits

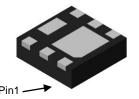
- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm²
- Low On-Resistance
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMT10H072LFDFQ is suitable for automotive applications requiring specific change control and is AEC-Q101 qualified, is PPAP capable, and is manufactured in IATF16949:2016 certified facilities.

Mechanical Data

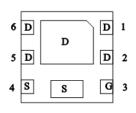
- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.0065 grams (Approximate)



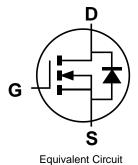




Top View Bottom View



Pin Out Bottom View



Ordering Information (Note 4)

Part Number	Case	Quantity per Reel
DMT10H072LFDFQ-7	U-DFN2020-6 (Type F)	3,000
DMT10H072LFDFQ-13	U-DFN2020-6 (Type F)	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

U-DFN2020-6 (Type F)



72 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: G = 2019)M = Month (ex: 9 = September)

Date Code Key

Year	2019	20	20	2021	2022	20	023	2024	2025	20)26	2027
Code	G		Н	ı	J		K	L	М		N	0
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

U-DFN2020-6 (Type F)



72 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 9 = 2019)

W = Week (ex: a = week27; z represents week 52 and 53)

X = Internal Code (ex: U = Monday)

Date Code Kev

Year	2019	2020	2021	2022	2023	2024	2025	2026	2027
Code	9	0	1	2	3	4	5	6	7

Week	1-26	27-52	53
Code	A-Z	a-z	Z

ſ	Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
ſ	Code	T	U	V	W	X	Y	Z

Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V_{DSS}	100	V
Gate-Source Voltage	V_{GSS}	±20	V	
0 6 0 1 1 10 10 10 10 10 10 10 10 10 10 10	T _A = +25°C		4	Δ.
Continuous Drain Current, V _{GS} = 10V (Note 7)	T _A = +70°C	ID	3.2	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	22	Α
Maximum Body Diode Continuous Current	Is	1.6	Α	
Avalanche Current, L=0.1mH (Note 5)	I _{AS}	6	Α	
Avalanche Energy, L=0.1mH (Note 5)	Eas	1.8	mJ	

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 6)	T _A = +25°C	D	0.8	W	
Total Fower Dissipation (Note 6)	$T_A = +70^{\circ}C$	P_{D}	0.5	VV	
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	149	°C/W		
Total Power Dissipation (Note 7)	T _A = +25°C		1.8	W	
Total Fower Dissipation (Note 7)	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	P _D	1.1	V V	
Thermal Resistance, Junction to Ambient (Note 7)	$R_{\theta JA}$	71	°C/W		
Thermal Resistance, Junction to Case (Note 7)	$R_{ heta JC}$	13	C/VV		
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-55 to +150	°C	

Notes: 5. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

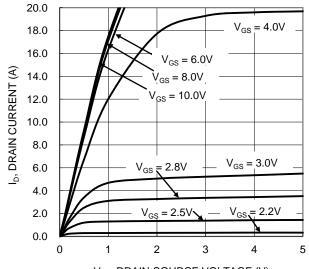
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)	•	•		•	•	
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 80V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)	*	•	•	•	•	
Gate Threshold Voltage	V _{GS(TH)}	1	_	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
		_	47	62	~ 0	$V_{GS} = 10V, I_D = 4.5A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	54	80	mΩ	$V_{GS} = 6V, I_{D} = 4A$
	, ,	_	64	110	mΩ	$V_{GS} = 4.5V, I_D = 2.6A$
Diode Forward Voltage	V _{SD}	_	0.7	1.0	V	V _{GS} = 0V, I _S = 1A
DYNAMIC CHARACTERISTICS (Note 9)	*	•	•	•	•	•
Input Capacitance	C _{iss}	_	228	_	pF	
Output Capacitance	Coss	_	89.3	_	pF	$V_{DS} = 50V, V_{GS} = 0V,$ - f = 1MHz
Reverse Transfer Capacitance	Crss	_	2.5	_	pF	
Gate Resistance	Rq	_	8.2	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qq	_	2.5	_	nC	
Total Gate Charge (V _{GS} = 10V)	Qq	_	4.5	_	nC	7, 50,4,4,54
Gate-Source Charge	Q _{qs}	_	0.6	_	nC	$V_{DS} = 50V, I_D = 4.5A$
Gate-Drain Charge	Q _{gd}	_	1.3	_	nC	7
Turn-On Delay Time	t _{D(ON)}	_	3.0	_	ns	
Turn-On Rise Time	t _R	_	3.1	_	ns	$V_{DS} = 50V, R_{L} = 11\Omega$
Turn-Off Delay Time	t _{D(OFF)}	_	12.3	_	ns	$V_{GS} = 10V, R_{GEN} = 3\Omega$
Turn-Off Fall Time	t _F	_	4.3	_	ns	
Reverse Recovery Time	t _{RR}	_	22.9	_	ns	1. 1.54 11/11 2004/
Reverse Recovery Charge	Q _{RR}	_	45.2	_	nC	$I_F = 4.5A$, di/dt = 300A/ μ s

Notes:

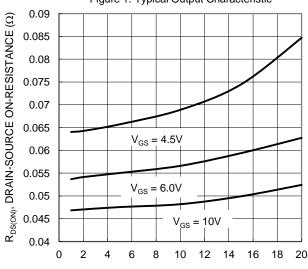
- 8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.







V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 1. Typical Output Characteristic



I_D, DRAIN-SOURCE CURRENT (A) Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

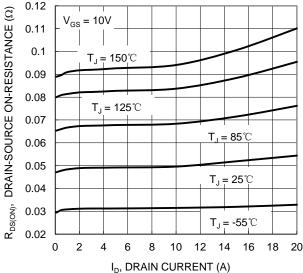


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

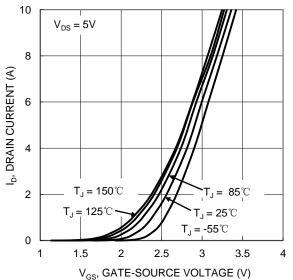
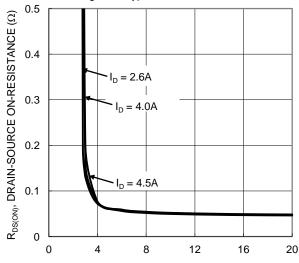


Figure 2. Typical Transfer Characteristic



V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 4. Typical Transfer Characteristic

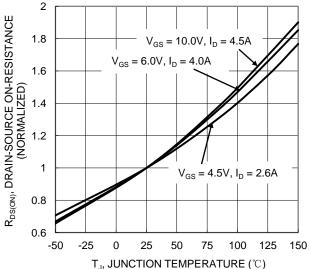
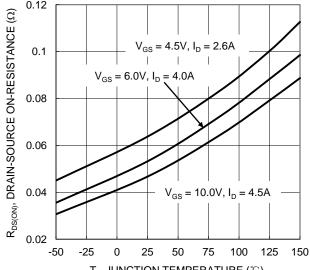


Figure 6. On-Resistance Variation with Junction Temperature







 T_J , JUNCTION TEMPERATURE (°C) Figure 7. On-Resistance Variation with Junction Temperature

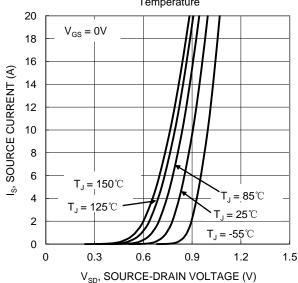
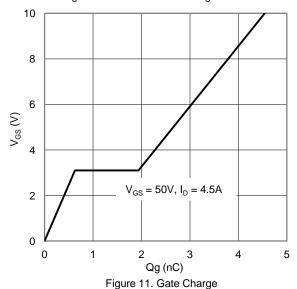
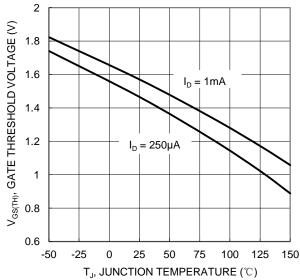
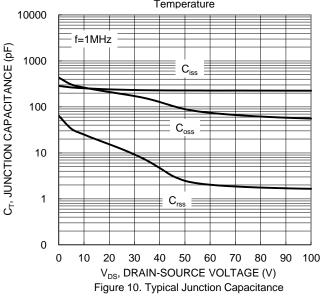


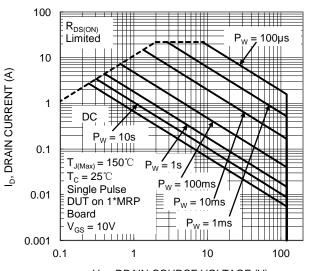
Figure 9. Diode Forward Voltage vs. Current





Figire 8. Gate Threshold Variation vs. Junction Temperature





V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



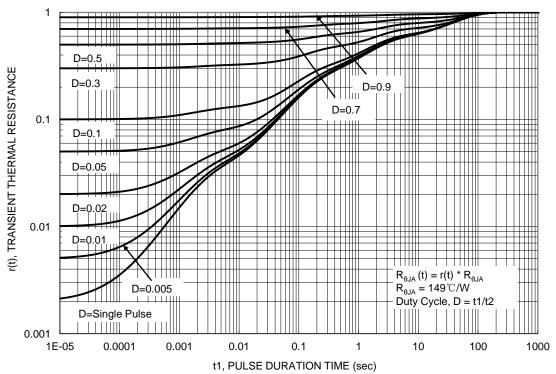


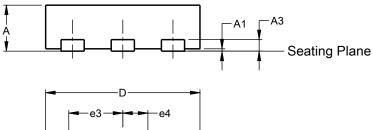
Figure 13. Transient Thermal Resistance

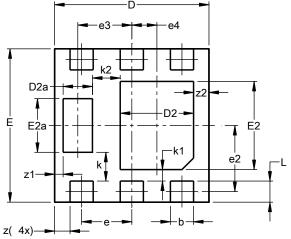


Package Outline Dimension

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)



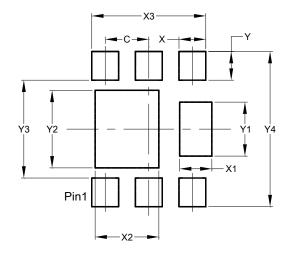


U-DFN2020-6						
		pe F)				
Dim	Min	Max	Тур			
Α	0.57	0.63	0.60			
A1	0.00	0.05	0.03			
A3	-	1	0.15			
b	0.25	0.35	0.30			
D	1.95	2.05	2.00			
D2	0.85	1.05	0.95			
D2a	0.33	0.43	0.38			
E	1.95	2.05	2.00			
E2	1.05	1.25	1.15			
E2a	0.65	0.75	0.70			
е	0.65 BSC					
e2	C).863 BS	SC			
e3	(0.70 BS	С			
e4	C).325 BS	SC			
k		0.37 BS	С			
k1		0.15 BS	С			
k2		0.36 BS	С			
L	0.225	0.325	0.275			
Z	0.20 BSC					
z1	C).110 BS	SC			
z2		0.20 BS				
All D	imens	ions in	mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)



Dimensions	Value (in mm)		
С	0.650		
Х	0.400		
X1	0.480		
X2	0.950		
Х3	1.700		
Υ	0.425		
Y1	0.800		
Y2	1.150		
Y3	1.450		
Y4	2.300		



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